

#### 2.7x1.2mm SMD CHIP LED LAMP

APE2712SURCK

HYPER RED

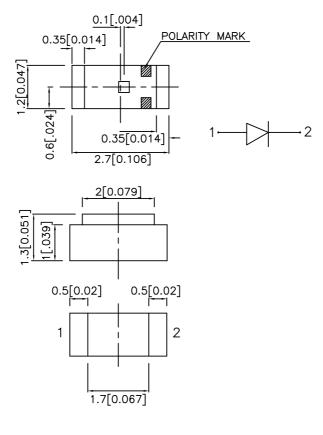
#### **Features**

- 2.7mmx1.2mm SMT LED,1.3mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE :2000PCS / REEL.
- RoHS COMPLIANT.

#### **Description**

The Hyper Red source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

#### **Package Dimensions**



#### Notes:

- All dimensions are in millimeters (inches).
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   Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. Specifications are subject to change without notice.

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#### **Selection Guide**

Part No.	Dice	Lens Type	Iv (mcd) @ 20 mA		Viewing Angle
		,,	Min.	Тур.	201/2
APE2712SURCK	HYPER RED (InGaAIP)	WATER CLEAR	70	150	120°

Note

#### Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	650		nm	IF=20mA
λD	Dominant Wavelength	Hyper Red	635		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	28		nm	IF=20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF	Forward Voltage	Hyper Red	1.95	2.5	V	IF=20mA
IR	Reverse Current	Hyper Red		10	uA	VR = 5V

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Hyper Red	Units	
Power dissipation	170	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	185	mA	
Reverse Voltage	5	V	
Operating / Storage Temperature	-40°C To +85°C		

Note

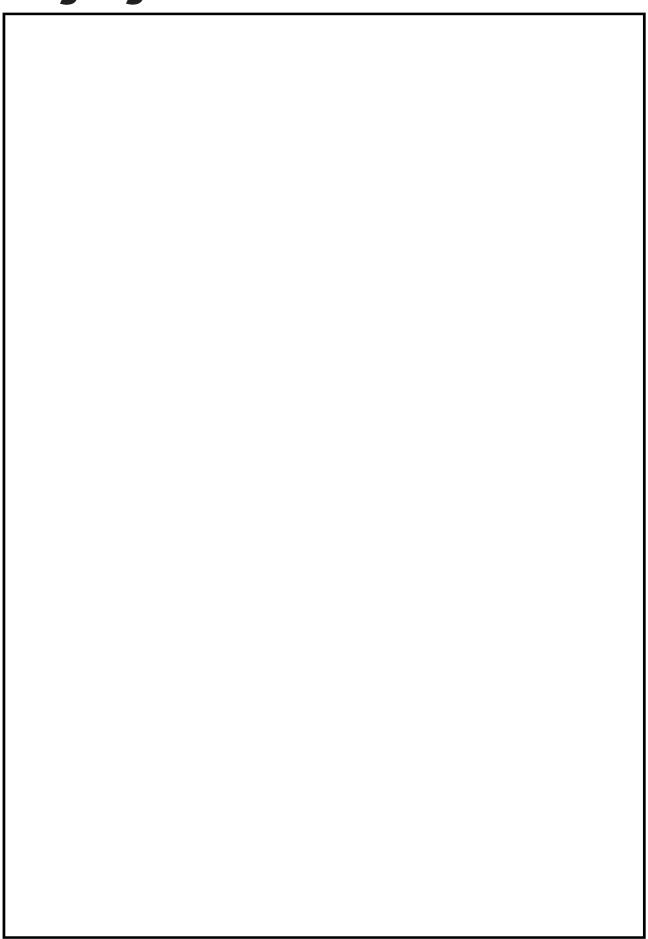
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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 $<sup>1.\,\</sup>theta1/2$  is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.



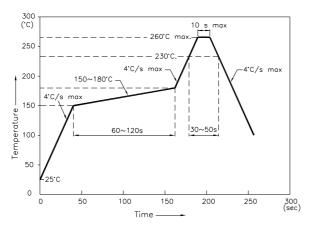


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#### APE2712SURCK

Reflow Soldering Profile For Lead-free SMT Process.

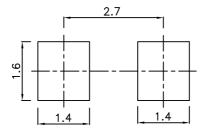


#### NOTES:

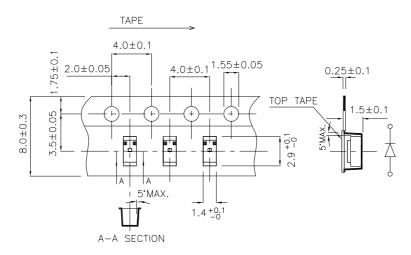
- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

### Recommended Soldering Pattern

(Units: mm)



### Tape Specifications (Units: mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage,luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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